

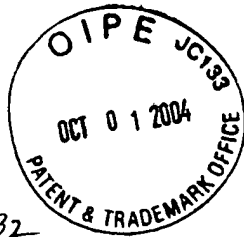
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:
Xu et al.

Serial No. 09/854,177
Filed: May 10, 2001

Patent No. 6,759,255 B2
Issued: July 6, 2004

For: METHOD AND SYSTEM FOR
DETECTING METAL
CONTAMINATION ON A
SEMICONDUCTOR WAFER



Atty. Docket No. 5589-00501

Group Art Unit: 2822

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313, on the date indicated below:

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Pamela Gerik
Pamela Gerik

TRANSMITTAL LETTER

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313

Dear Sir:

Transmitted herewith for filing in the captioned case are the following:

- (1) Form PTO-1050, **submitted in duplicate**. Errors which occur at important points in the captioned patent or which may otherwise affect the understanding or interpretation of the patent are thereon corrected.
- (2) A return postcard to acknowledge receipt of these materials. Please stamp and return this postcard to the undersigned.

All of the errors shown in PTO-1050 are due to Patent Office oversights. A Certificate of Correction is requested under 35 U.S.C. § 254. Applicants believe that no fees are required, however, should any fees be required, please deduct them from Conley Rose, P.C. Deposit Account No. 50-3268/5589-00501.

Respectfully submitted,

Ann Marie Mewherter
Reg. No. 50,484
Agent for Applicant(s)

Certificate
OCT 06 2004
of Correction

Conley Rose, P.C.
P.O. Box 684908
Austin, TX 78768-4908
(512) 476-1400
Date: September 29, 2004

OCT 08 2004

UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATE OF CORRECTIONPATENT NO. 6,759,255 *B2*

DATED: July 6, 2004

INVENTOR(S): Xu et al.

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

In the Claims:Claim 2, col. 23, line 31

After the phrase "conductor substrate," please delete "comprise" and substitute therefor --comprises--.

Claim 10, col. 23, line 63

After the phrase "comprises approximately," please delete " $-1 \times 10^{31} \text{ } ^6 \text{ C/cm}^2$ " and substitute therefor -- $-1 \times 10^{-6} \text{ C/cm}^2$ --.

Claim 11, col. 24, line 9

After the phrase "and wherein," please delete "deposing" and substitute therefor --depositing--.

Claim 18, col. 24, line 41

Please delete "annealing field" and substitute --a tunneling field--.

Claim 31, col. 25, line 33

After the phrase "the semiconductor," please delete "substate" and substitute therefor --substrate--.

MAILING ADDRESS OF SENDER:

Kevin L. Daffer, Esq.,
CONLEY ROSE, P.C.
P.O. Box 684908
Austin, TX 78768-4908

PATENT NO. 6,759,255 *B2*

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UNITED STATES PATENT AND TRADEMARK OFFICE

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CONLEY ROSE, P.C.
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